

# MJD44H11, MJD45H11

## Complementary power transistors

Datasheet - production data

### Features

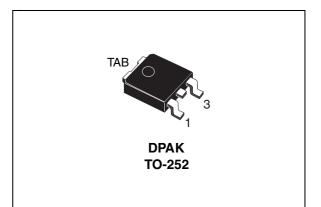
- Low collector-emitter saturation voltage
- Fast switching speed
- Surface-mounting TO-252 (DPAK) power package in tape and reel (suffix "T4")

## **Applications**

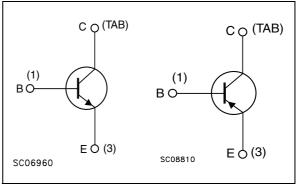
- Power amplifier
- Switching circuits

## Description

These devices are manufactured using low voltage multi epitaxial planar technology. They are intended for general-purpose linear and switching applications.



#### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order codes	Marking	Polarity	Package	Packaging
MJD44H11T4	MJD44H11	NPN	DPAK	Tape and reel
MJD45H11T4	MJD45H11	PNP	DPAK	Tape and reel

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This is information on a product in full production.

# 1 Absolute maximum ratings

Table 2. Absolu	te maximum ratings
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Symbol	Parameter	Value	Unit
V <sub>CEO</sub>	Collector-emitter voltage (I <sub>B</sub> = 0)	80	V
V <sub>EBO</sub>	Emitter-base voltage (I <sub>C</sub> = 0)	5	V
۱ <sub>C</sub>	Collector current	8	А
I <sub>CM</sub>	Collector peak current	16	А
P <sub>TOT</sub>	Total dissipation at T <sub>case</sub> = 25°C	20	W
T <sub>STG</sub>	Storage temperature	-55 to 150	°C
TJ	Max. operating junction temperature	150	°C

#### Note: For PNP types voltage and current values are negative.

Table 3.	Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case max	6.25	°C/W



## 2 Electrical characteristics

 $T_{case} = 25 \ ^{\circ}C$ ; unless otherwise specified.

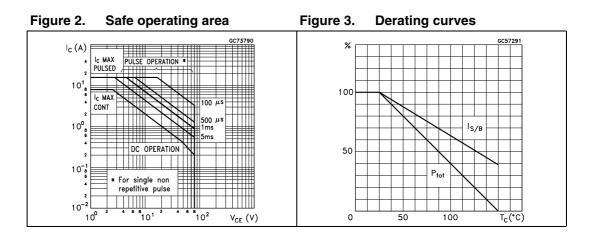
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 30 mA		80	-		V
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 80 V			-	10	μA
I <sub>EBO</sub>	Emitter cut-off current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 5 V			-	50	μA
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	I <sub>C</sub> = 8 A	I <sub>B</sub> = 0.4 A		-	1	V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	I <sub>C</sub> = 8 A	I <sub>B</sub> = 0.8 A		-	1.5	v
h <sub>FE</sub> <sup>(1)</sup>	DC eurrent sein	I <sub>C</sub> = 2 A	$V_{CE} = 1 V$	60	-		
	DC current gain	$I_{\rm C} = 4  \rm A$	$V_{CE} = 1 V$	40	-		

 Table 4.
 Electrical characteristics

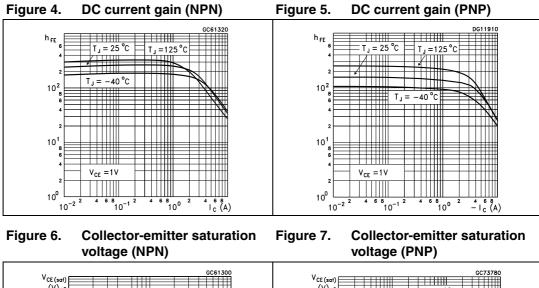
1. Pulse test: pulse duration  $\leq$ 300 µs, duty cycle  $\leq$ 2 %.

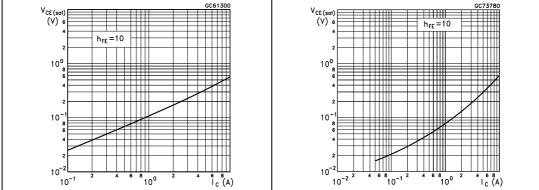
Note: For PNP types voltage and current values are negative.

## 2.1 Typical characteristic (curves)









## 3 Package mechanical data

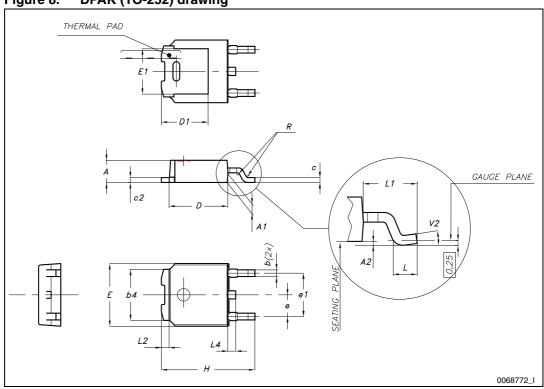
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

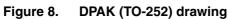


Dim	mm				
Dim. —	Min.	Тур.	Max.		
A	2.20		2.40		
A1	0.90		1.10		
A2	0.03		0.23		
b	0.64		0.90		
b4	5.20		5.40		
с	0.45		0.60		
c2	0.48		0.60		
D	6.00		6.20		
D1		5.10			
E	6.40		6.60		
E1		4.70			
е		2.28			
e1	4.40		4.60		
Н	9.35		10.10		
L	1		1.50		
L1		2.80			
L2		0.80			
L4	0.60		1		
R		0.20			
V2	0°		8°		

Table 5. DPAK (TO-252) mechanical data







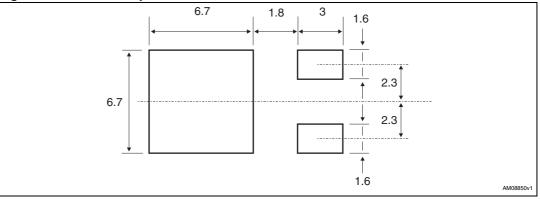


## 4 Packaging mechanical data

Tape				Reel		
<b>D</b> .	mm			mm		
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	А		330	
B0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
Е	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1		Base qty.	2500	
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

Table 6.	DPAK (TO-25	2) tane and ree	I mechanical data
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### Figure 9. DPAK footprint<sup>(a)</sup>

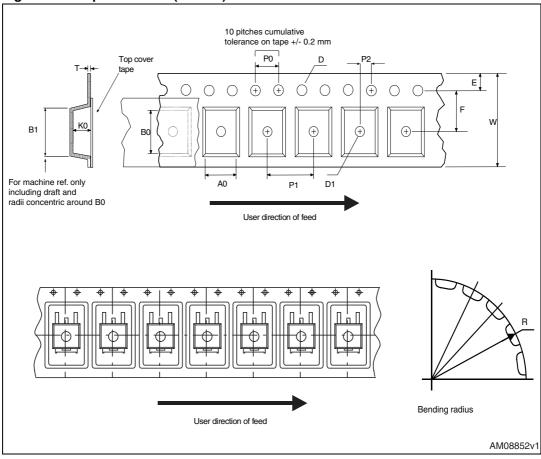


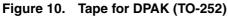
a. All dimensions are in millimeters

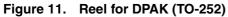
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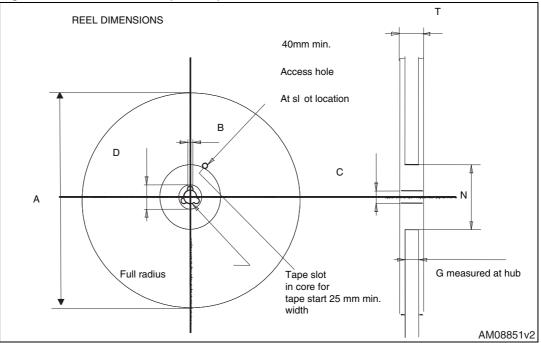


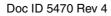
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# 5 Revision history

Table 7.Document revision history

Date	Revision	evision Changes	
21-Jun-2004 2 Document migration, no content change.			
06-Aug-2009	3	Updated mechanical data.	
18-May-2012 4		Updated: mechanical data Inserted: packaging mechanical data	



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